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IN THE U.S. PATENT AND TRADEMARK OFFICE

May 7, 2001

Applicant(s) : Chikao IKENAGA et al.
For : FRAME FOR SEMICONDUCTOR PACKAGE
Atty. Docket No.: OPS Case 533

Assistant Commissioner for Patents
Washington, DC 20231

AMENDMENT BEFORE FIRST OFFICE ACTION

Sir:

Prior to issuance of the first Office Action in the
above-identified application, kindly enter the following:

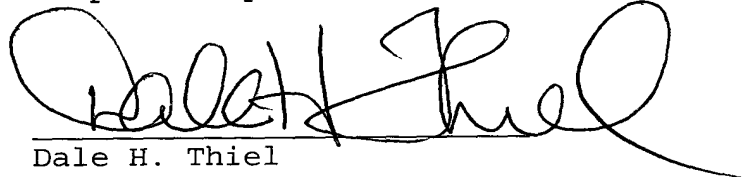
IN THE SPECIFICATION

Kindly amend Paragraphs 0014 and 0015, as indicated on
the attached marked-up page. A replacement page, showing
Paragraphs 0014 and 0015 in clean form, is also attached.

REMARKS

The above Amendment is being submitted to conform the
brief descriptions of Figures 3 and 4 with the drawing sheets.

Respectfully submitted,


Dale H. Thiel

DHT/jp

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Reg. No. 24 323
Reg. No. 25 072
Reg. No. 22 724
Reg. No. 32 549
Reg. No. 36 589
Reg. No. 31 257
Reg. No. 24 949
Reg. No. 40 694
Reg. No. 36 328

Encl: Marked-up Paragraphs 0014 and 0015 (1 page)
Replacement Paragraphs 0014 and 0015 (1 page)

112.9803